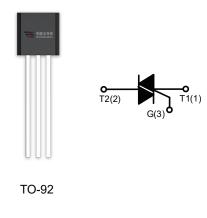


DESCRIPTION:

The Z0107NA SCR series with the parallel resistor between Gate and Cathode are especially recommended for use on straight hair, igniter, anion generator, etc.

MAIN FEATURES

Symbol	Value	Unit
I _{T(RMS)}	1	А
Ітѕм	16	А
V _{TM}	≤1.5	V



ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Storage junction temperature range		T _{stg}	-40 - 150	$^{\circ}$ C
Operating junction tempe	rature range	Tj	-40 - 125	$^{\circ}$
Repetitive peak off-state voltage (T _j =25℃)		VDRM	600/800	V
Repetitive peak reverse voltage (Tj=25℃)		VRRM	600/800	V
Non repetitive surge peak off-state voltage		V _{DSM}	V _{DRM} + 100	V
Non repetitive peak reverse voltage		V _{RSM}	V _{RRM} + 100	V
RMS on-state current	TO-92 (Tc=50°C)	I _{T(RMS)}	1	А
Non repetitive surge peak on-state current (full cycle, F=50Hz)		Ітѕм	16	А
I ² t value for fusing (tp=10ms)		l ² t	1.28	A ² s
Critical rate of rise of on-state current (I _G =2×I _{GT})		dI/dt	20	A/µs
Peak gate current		I _{GM}	2	Α
Average gate power dissipation		P _{G(AV)}	0.5	W
Peak gate power		P _{GM}	5	W

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ELECTRICAL CHARACTERISTICS (T_j=25°C unless otherwise specified)

Symbol	Test Condition	Quadrant		Va	lue	Hoit
Symbol				Т	D	Unit
I _{GT}		I - II -III	MAX	5	5	mA
IGI	V _D =12V R _L =33Ω	IV		5	10	
V _G T		ALL	MAX	1.3		V
V _{GD}	$V_D=V_{DRM}T_j=125$ °C RL=3.3KΩ	ALL	MIN	0.2		V
I.	I _L I _G =1.2I _{GT}	I -III	MAX	5	5	mA
"L		II -IV		10	20	
Ін	I _T =200mA		MAX	5	7	mA
dV/dt	V _D =2/3V _{DRM} Gate Open T _j =125℃		MIN	15	20	V/µs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V _{TM}	I _{TM} =1.4A tp=380μs	Tj=25℃	1.5	V
IDRM	VD=VDRM VR=VRRM	Tj=25℃	5	μΑ
I _{RRM}		Tj=125℃	500	μA

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
R _{th(j-c)}	junction to case(AC)	TO-92	60	°C/W



FIG.1: Maximum power dissipation versus RMS on-state current

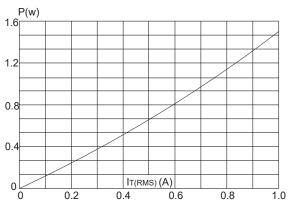


FIG.3: Surge peak on-state current versus number of cycles

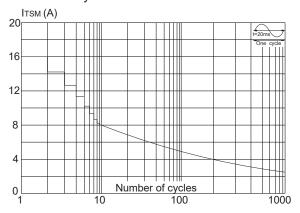


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms and corresponding value of I²t (dl/dt < 20A/µs)

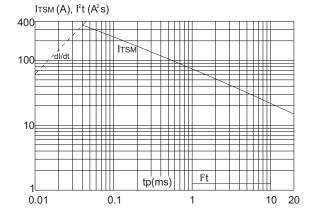


FIG.2: RMS on-state current versus case temperature

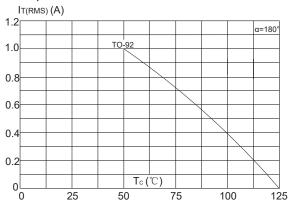


FIG.4: On-state characteristics (maximum values)

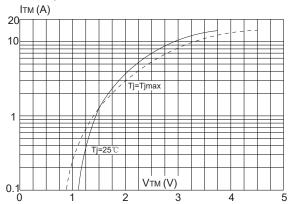


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature

